



PRODUCT BULLETIN
Generic Copy

ISSUE DATE: 20-Jun-2012
NOTIFICATION: 15176
TITLE: REVISED SSOP CASE OUTLINE SPECIFICATION
EFFECTIVE DATE: 21-Jun-2012

DEVICE(S)

MPN
MP3H6115A6T1
MP3H6115A6U
MPXH6101A6T1
MPXH6101A6U
MPXH6115A6T1
MPXH6115A6U
MPXH6250A6T1
MPXH6250A6U
MPXH6300A6T1
MPXH6300A6U
MPXHZ6115A6T1
MPXHZ6115A6U
MPXHZ6116A6T1
MPXHZ6116A6U
MPXHZ6130A6U
MPXHZ6250A6T1
MPXHZ6250A6U
MPXHZ6400A6
MPXHZ6400A6T1
MPXHZ6401A6T1
MPXHZ6401A6U

AFFECTED CHANGE CATEGORIES

- DEVICE SPECIFICATION / ERRATA

DESCRIPTION OF CHANGE

Freescale Semiconductor has found an error in the outline drawing of the Pressure SSOP package. The drawing has been updated to include revised parameters as below:

Update 1: Package height changed from 0.145-0.165in to 0.155-0.175in.

Update 2: Standoff height changed from 0.002-0.01in to 0-0.008in.

Update 3: Foot length changed from 0.038-0.048in to 0.028-0.048in.

The reason for this update is to correct errors in previous documentation. The updated outline drawing is attached and will also be available in the datasheets of Pressure products using SSOP packages on

<http://www.freescale.com/webapp/sps/site/taxonomy.jsp?nodeId=01126990368716>

REASON FOR CHANGE

The SSOP package outline drawing has been updated.

ANTICIPATED IMPACT OF PRODUCT CHANGE(FORM, FIT, FUNCTION, OR RELIABILITY)

No changes have been made to the current production device.

NOTE:

THE CHANGE(S) SPECIFIED IN THIS NOTIFICATION WILL BE IMPLEMENTED ON THE EFFECTIVE DATE LISTED ABOVE. To request further data or inquire about the notification, please enter a [Service Request](#)

For sample inquiries - please go to www.freescale.com

QUAL DATA AVAILABILITY DATE: 26-Apr-2012

QUALIFICATION STATUS: COMPLETED

QUALIFICATION PLAN:

N/A

RELIABILITY DATA SUMMARY:

N/A

ELECTRICAL CHARACTERISTIC SUMMARY:

N/A

CHANGED PART IDENTIFICATION:

N/A

SAMPLE AVAILABILITY DATE: 26-Apr-2012

ATTACHMENT(S):

External attachment(s) FOR this notification can be viewed AT:

[15176_MPXA6115A.pdf](#)
